

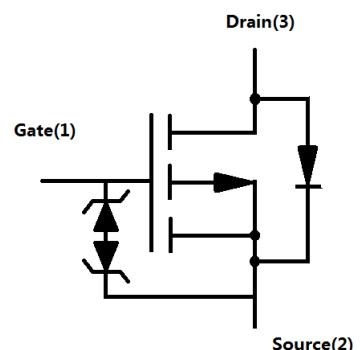
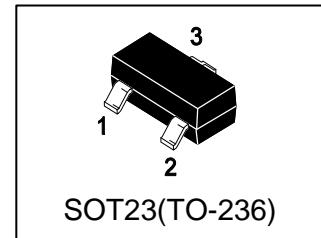
LP2301ELT1G

S-LP2301ELT1G

20V P-Channel Enhancement-Mode MOSFET

1. FEATURES

- VDS = -20V
- RDS(ON),VGS@-2.5V,IDS@-2.0A≤156mΩ
- RDS(ON),VGS@-4.5V,IDS@-2.8A≤110mΩ
- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.
- Advanced trench process technology
- High density cell design for ultra low on-resistance
- Fully characterized avalanche voltage and current improved shoot-through FOM
- ESD protected,ESD > 1kV HBM



2. APPLICATIONS

- Simple drive requirement
- Small package outline
- Surface mount device

3. DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
LP2301ELT1G	YES	3000/Tape&Reel
LP2301ELT3G	YES	10000/Tape&Reel

4. MAXIMUM RATINGS($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	VDSS	-20	V
Gate-to-Source Voltage – Continuous	VGS	±8	V
Drain Current – Continuous TA = 25°C	ID	-2.8	A
– Pulsed(Note 1)	IDM	-11	

5. THERMAL CHARACTERISTICS

Parameter	Symbol	Limits	Unit
Maximum Power Dissipation	PD	0.9	W
Thermal Resistance, Junction-to-Ambient(Note 2)	R _{θJA}	140	°C/W
Junction and Storage temperature	T _{J,Tstg}	-55~+150	°C

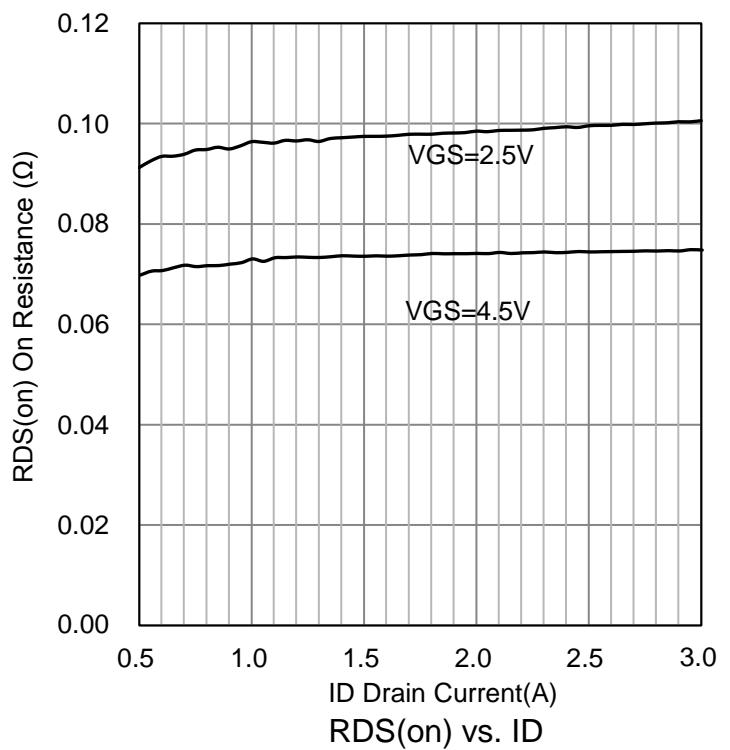
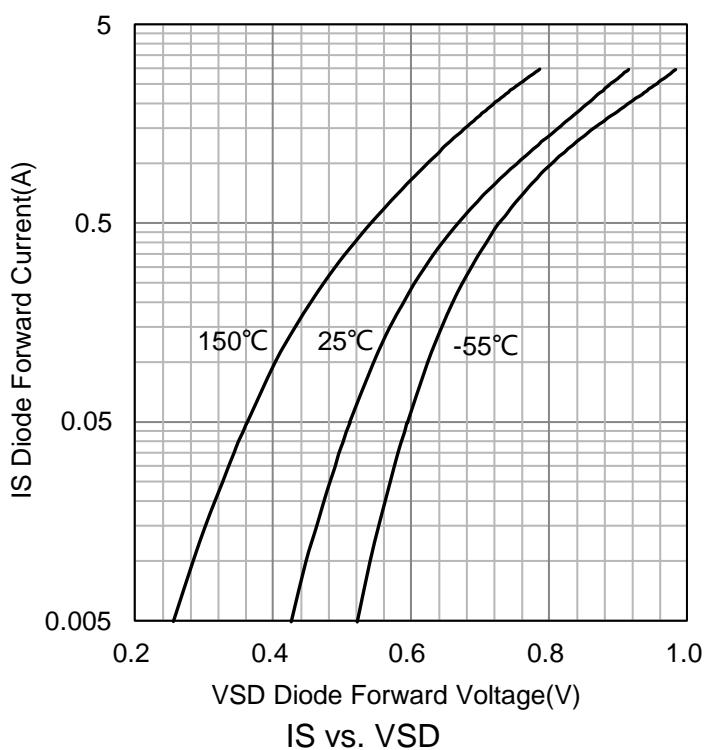
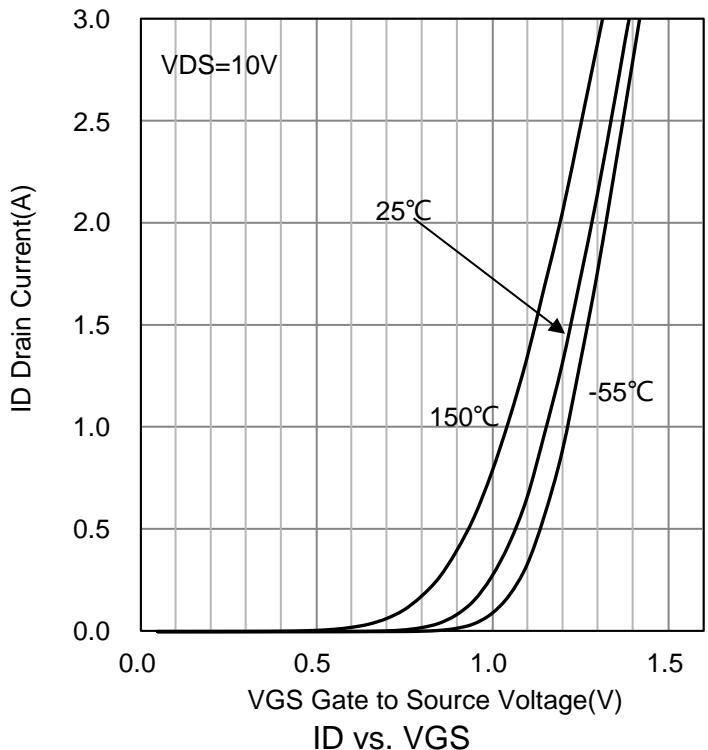
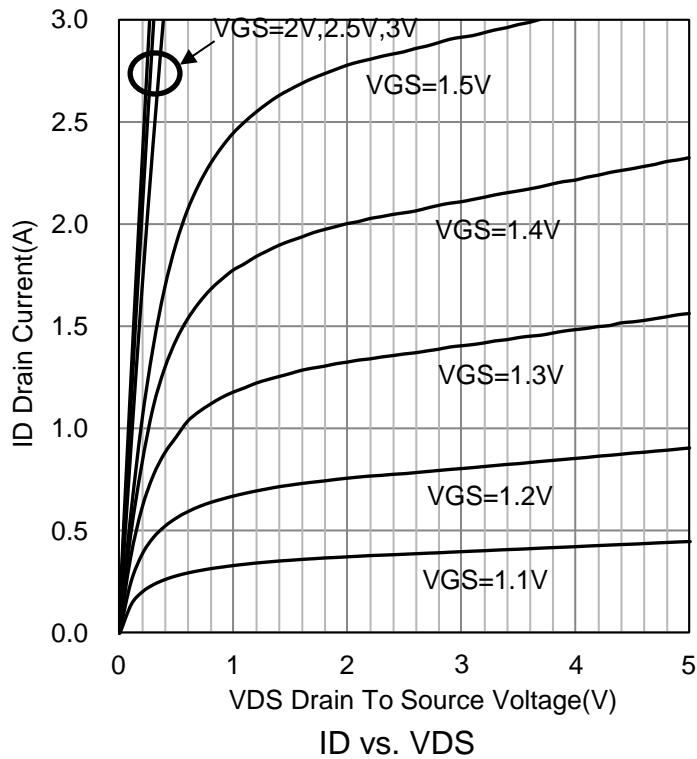
1. Repetitive Rating: Pulse width limited by the Maximum junction temperature.

2. 1-in² 2oz Cu PCB board.

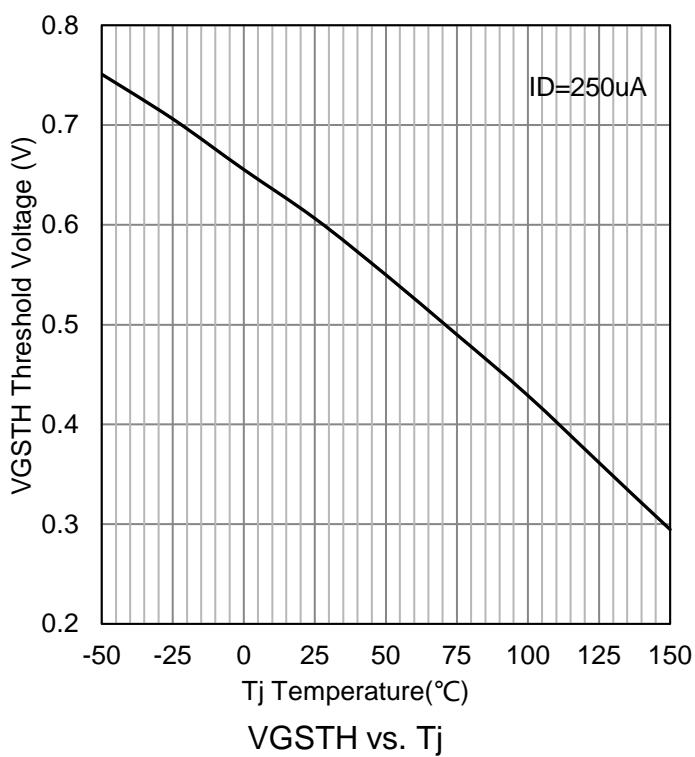
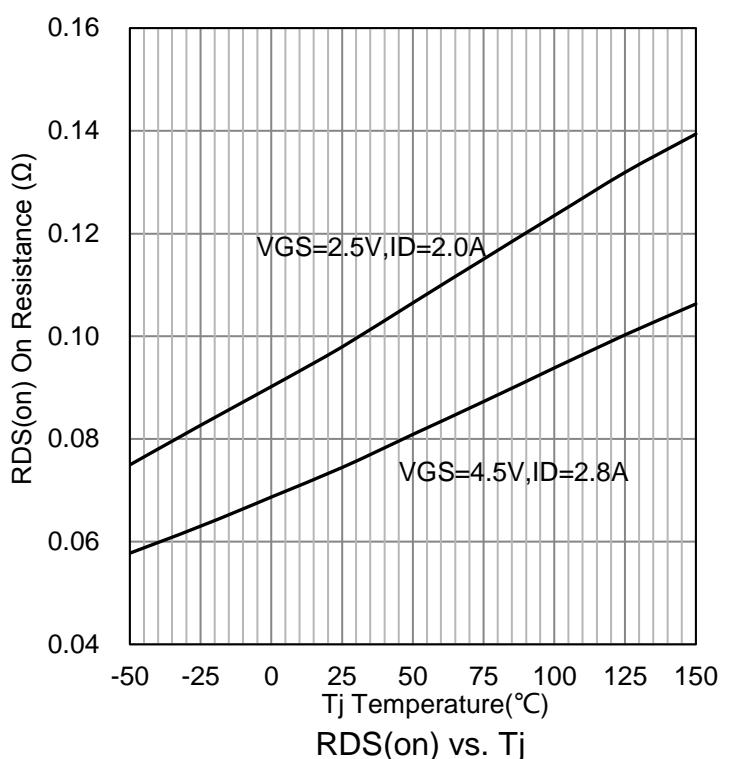
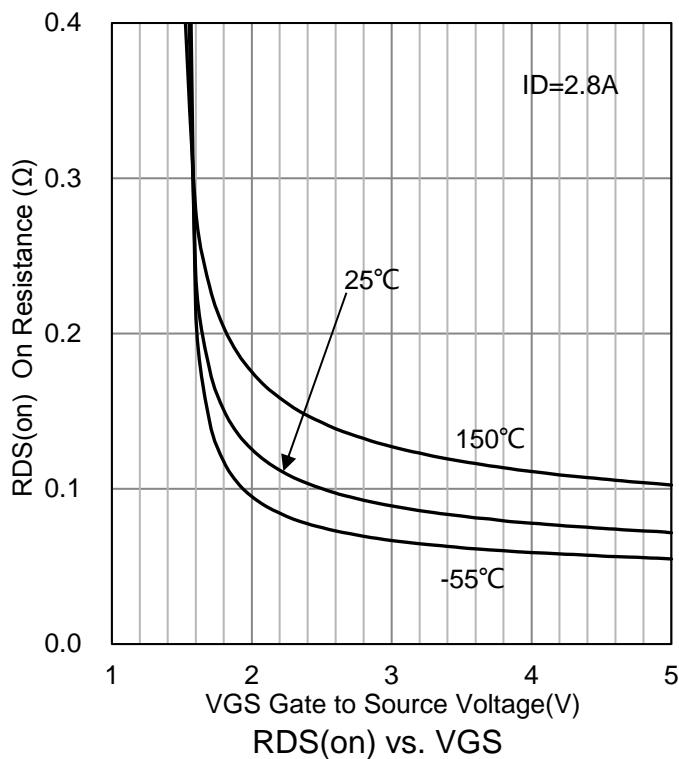
6. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
STATIC					
Drain–Source Breakdown Voltage (VGS = 0, ID = -250µA)	VBRDSS	-20	-	-	V
Zero Gate Voltage Drain Current (VGS = 0, VDS = -9.6 V)	IDSS	-	-	-1	µA
Gate–Body Leakage Current, Forward (VGS = ± 8 V)	IGSS	-	-	± 10	µA
Gate Threshold Voltage (VDS = VGS, ID = -250µA)	VGS(th)	-0.4	-0.65	-0.9	V
Static Drain–Source On–State Resistance (VGS = -4.5 V, ID = -2.8 A) (VGS = -2.5 V, ID = -2 A)	RDS(on)	-	90 110	110 156	mΩ
DYNAMIC					
Total Gate Charge	(VDS = -10V, VGS = -10V, ID = -1.6A)	Qg(-10V)	-	7.8	-
Total Gate Charge		Qg(-4.5V)	-	3.5	-
Gate-Source Charge		Qgs	-	0.5	-
Gate-Drain Charge		Qgd	-	1.2	-
Input Capacitance (VGS = 0 V, f = 1.0MHz, VDS= -6 V)	Ciss	-	520	-	pF
Output Capacitance (VGS = 0 V, f = 1.0MHz, VDS= -6 V)	Coss	-	55	-	pF
Reverse Transfer Capacitance (VGS = 0 V, f = 1.0MHz, VDS= -6 V)	Crss	-	17	-	pF
Turn-On Delay Time	(VDD = -6V, RL = 6Ω ID = -1A, VGEN = -4.5V RG = 6Ω)	td(on)	-	1350	-
Rise Time		tr	-	830	-
Turn-Off Delay Time		td(off)	-	5500	-
Fall Time		tf	-	1550	-
Forward Voltage (VGS = 0 V, ISD = -0.75 A)	VSD	-	-0.8	-1.2	V

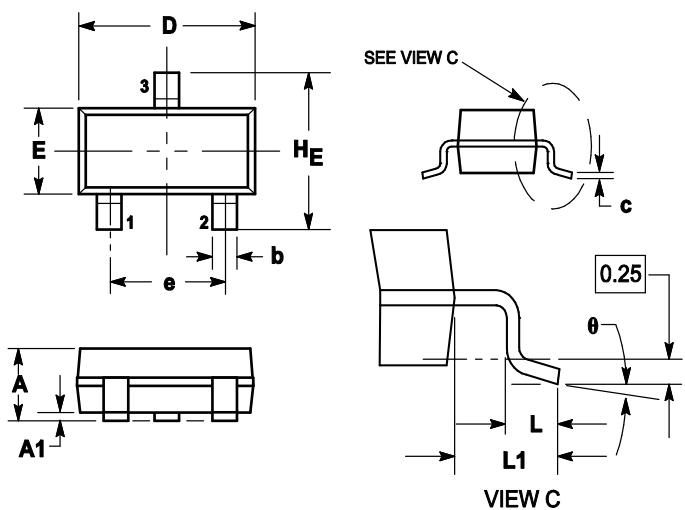
7. ELECTRICAL CHARACTERISTICS CURVES



7. ELECTRICAL CHARACTERISTICS CURVES(Con.)



8.OUTLINE AND DIMENSIONS

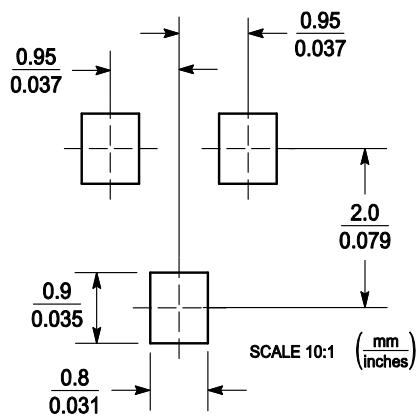


Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1	1.11	0.035	0.04	0.044
A1	0.01	0.06	0.1	0.001	0.002	0.004
b	0.37	0.44	0.5	0.015	0.018	0.02
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.9	3.04	0.11	0.114	0.12
E	1.20	1.3	1.4	0.047	0.051	0.055
e	1.78	1.9	2.04	0.07	0.075	0.081
L	0.10	0.2	0.3	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
H _E	2.10	2.4	2.64	0.083	0.094	0.104
θ	0°	---	10°	0°	---	10°

9.SOLDERING FOOTPRINT





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